

Data sheet acquired from Harris Semiconductor SCHS048C – Revised October 2003

CMOS Liquid-Crystal Display Drivers

High-Voltage Types (20-Volt Rating)

CD4054B - 4-Segment Display Driver

CD4055B — BCD to 7-Segment Decoder/Driver with "Display-Frequency" Output

CD4056B — BCD to 7-Segment Decoder/Driver with Strobed-Latch Function

single-digit BCD-to-7-segment decoder/driver circuits that provide level-shifting functions on the chip. This feature permits the BCD input-signal swings (VDD to VSS) to be the same as or different from the 7-segment output-signal swings (VDD to VEE). For example, the BCD input-signal swings (VDD to VSS) may be as small as 0 to -3 V, whereas the output-display drive-signal swing (VDD to VEE) may be as large as from 0 to -15V. If VDD to VEE exceeds 15 V, VDD to VSS should be at least 4V (0 to -4V).

The 7-segment outputs are controlled by the DISPLAY-FREQUENCY (DF) input which causes the selected segment outputs to be low, high, or a square-wave output (for liquid-crystal displays). When the DF input is low the output segments will be high when selected by the BCD inputs. When the DF input is high, the output segments will be low when selected by the BCD inputs. When a square-wave is present at the DF input, the selected segments will have a square-wave output that is 180° out of phase with the DF input. Those segments which are not selected will have a squarewave output that is in phase with the input. DF square-wave repetition rates for liquidcrystal displays usually range from 30 Hz (well above flicker rate) to 200 Hz (well below the upper limit of the liquid-crystal frequency response). The CD4055B provides a level-shifted high-amplitude DF output which is required for driving the common electrode in liquid-crystal displays. The CD4056B provides a strobed-latch function at the BCD inputs. Decoding of all input combinations on the CD4055B and CD4056B provides displays of 0 to 9 as well as L. P. H, A, -, and a blank position.

The CD4054B provides level shifting similar to the CD4055B and CD4056B independently strobed latches, and common DF control on 4 signal lines. The CD4054B is intended to provide drive-signal compatibility with the CD4055B and CD4056B 7-segment decoder types for the decimal point, colon, polarity, and similar display lines. A level-shifted high-amplitude DF output can be obtained from any CD4054B output line by connect-

CD4054B, CD4055B, CD4056B Types

Features:

- Operation of liquid crystals with CMOS circuits provides ultra-low-power displays
- Equivalent ac output drive for liquidcrystal displays — no external capacitor required
- Voltage doubling across display, e.g.
 VDD VEE = 18 V results in effective
 36 V p-p drive across selected display segments
- Low- or high-output level dc drive for other types of displays
- On-chip logic-level conversion for different input- and output-level swings
- Full decoding of all input combinations:
 0-9, L, H, P, A,-, and blank positions
- Strobed-latch function—CD4054B Series and CD4056B Series
- DISPLAY-FREQUENCY (DF) output for liquid-crystal common-line drive signal— CD4055B Series (CD4054B Series also: see introductory text)
- 100% tested for quiescent current at 20 V
- Maximum input current of 1 μA at 18 V over full package temperature range; 100 nA at 18 V and 25°C
- Noise margin (over full package temperature range):

1 V at V_{DD} = 5 V 2 V at V_{DD} = 10 V 2.5 V at V_{DD} = 15 V

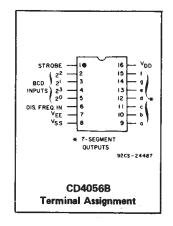
5-V, 10-V, and 15-V parametric ratings

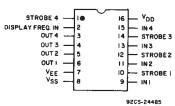
Applications

- General-purpose displays
- Calculators and meters
- Wall and table clocks
- Industrial control panels
- Portable lab instruments
- Panel meters
- Auto dashboard displays
- Appliance control panels

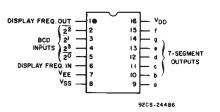
ing the corresponding input and strobe lines to a low and high level, respectively and applying a square wave to DFIN. The CD4054B may also be utilized for logic-level "up conversion" or "down conversion". For example, input-signal swings (VDD to VSS) from +5 to 0 V can be converted to outputsignal swings (VDD to VEE) of +5 to -5 V. The level-shifted function on all three types permits the use of different input- and output-signal swings. The input swings from a low level of VSS to a high level of VDD while the output swings from a low level of VEE to the same high level of VDD. Thus, the input and output swings can be selected independently of each other over a 3-to-18 V range. VSS may be connected to VEE when no level-shift function is required.

For the CD4054B and CD4056B, data are





CD4054B Terminal Assignment

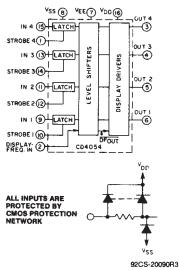


CD40558 Terminal Assignment

transferred from input to output by placing a high voltage level at the strobe input. A low voltage level at the strobe input latches the data input and the corresponding output segments remain selected (or non-selected) while the strobe is low.

Whenever the level-shifting function is required, the CD4055B can be used by itself to drive a liquid-crystal display (Fig.16 and Fig.20). The CD4056B, however, must be used together with a CD4054B to provide the common DF output (Fig.19). The capability of extending the voltage swing on the negative end (this voltage cannot be extended on the positive end) can be used to advantage in the setup of Fig.18. Fig.17 is common to all three types.

The CD4054B-, CD4055B-, and CD4056B-series types are supplied in 16-lead dual-in-line plastic packages (E suffix), 16-lead small-outline packages (M, M96, MT, and NSR suffixes), and 16-lead thin shrink small-outline packages (PW and PWR suffixes). The CD4054B- and CD4056B-series types also are supplied in 16-lead hermetic dual-in-line ceramic packages (F3A suffix).



90 (O) -(12) d -(15) VDD ALL INPUTS ARE PROTECTED BY CMOS PROTECTION NETWORK 92CS-20092R2

Fig.1 - CD4054B functional diagram.

Fig.2 - CD4055B functional diagram.

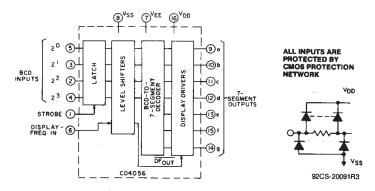


Fig.3 - CD4056B functional diagram.

CD4054B TRUTH TABLE

DF	IN	ST	OUT
0	0	1	0
1	0	1	1
0	1	1	1
1	1	1	0
Х	Х	0	•

X = Don't Care.

*Depends upon the input mode previously applied when ST = 1.

TRUTH TABLE FOR CD4055B and CD4056B

- 11	NPU"	r co	DE	OUTPUT STATE								DISPLAY CHARAC-
23	22	21	20	а	ь	C	d	е	f	g		TER
0	0	0	0	1	1	1	1	1	1	0		i
0	0	0	1	0	1	1	0	0	0	0		
0	0	1	0	1	1	0	1	1	0	1		<u>,=</u> '
0	0	1	1	1	1	1	1	0	0	1		=
0	1	0	0	0	1	1	0	0	1	1		1—;
0	1	0	1	1	0	1	1	0	1	1	П	<u>'</u>
0	1	1	0	1	0	1	1	1	1	1	\prod	<u> =</u> ,
0	1	1	1	1	1	1	0	0	0	0		
1	0	0	0	1	1	1	1	1	1	1	$\ $	
1	0	0	1	1	1	1	1	0	1	1		'='
1	0	1	0	0	0	0	1	1	1	0		1
1	0	1	1	0	1	1	0	1	1	1	I	
1	1	0	0	1	1	0	0	1	1	1	\prod	
1	1	0	1	1	1	1	0	1	1	1		; = ;
1	1	1	0	0	0	0	0	0	0	1	$\ $	
1	1	1	1	0	0	0	0	0	0	0	\prod	BLANK

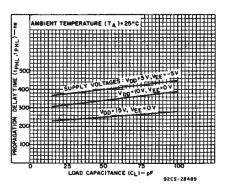


Fig.4 - Typical propagation delay time vs. load capacitance for CD4054B.

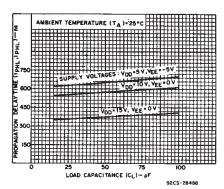


Fig.5 — Typical propagation delay time vs. load capacitance for CD4055 and CD4056B.

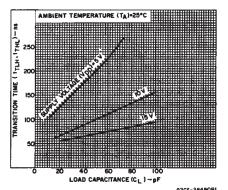


Fig.6 - Typical transition time vs. load capacitance.

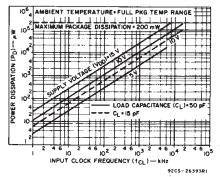


Fig.7 - Typical input clock frequency vs. power dissipation.

MAXIMUM RATINGS, Absolute-Maximum Values:	
DC SUPPLY-VOLTAGE RANGE, (V _{DD})	
Voltages referenced to VSS Terminal)	0.5V to +20V
INPUT VOLTAGE RANGE, ALL INPUTS	
DC INPUT CURRENT, ANY ONE INPUT	±10mA
POWER DISSIPATION PER PACKAGE (PD):	
For $T_A = -55^{\circ}C$ to $+100^{\circ}C$	500mW
For T _A = +100°C to +125°C	12mW/OC to 200mW
DEVICE DISSIPATION PER OUTPUT TRANSISTOR	
FOR TA = FULL PACKAGE-TEMPERATURE RANGE (All Package Types)	100mW
OPERATING-TEMPERATURE RANGE (TA)	55°C to +125°C
STORAGE TEMPERATURE RANGE (T _{stg})	65°C to +150°C
LEAD TEMPERATURE (DURING SOLDERING):	
At distance 1/16 \pm 1/32 inch (1.59 \pm 0.79mm) from case for 10s max	+265°C

MBIENT TEMPERATURE (TA)=25°C 5 IO I5 DRAIN-TO-SOURCE VOLTAGE (V_{DS})-V 92C9-35963

Fig.8 - Typical n-channel output low (sink) current characteristics.

NT TEMPERATURE (TA) - 25°C DRAIN-TO-SOUR E VOLTAGE (VDS)-V

Fig.9 - Minimum n-channel output low (sink) current characteristics.

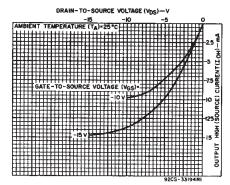


Fig. 10 - Typical p-channel output high (source) current characteristics.

DRAIN-TO-SOURCE VOLTAGE (VDS)-V

Fig. 13 — Minimum p-channel output high (source) current characteristics.

STATIC ELECTRICAL CHARACTERISTICS

	CONDITIONS			LIMITS AT INDICATED TEMPERATURES (°C)									
Characteristic	V _{EE}	V _{SS}	4	V _{IN}	V _{DD}	<u> </u>	<u> </u>		Ī —	T	+25°C		Units
				L		-55°	-40°	+850	+1250	Min.	Тур.	Max.	1
Quiescent Device	- 5	0			5		5	150	150	-	0.04	5	μА
Current, IDD	0	0			10		10	300	300		0.04	10	1 "
MAX.	0	0	ļ		15		20	600	600	_	0.04	20	1
	0	0	<u> </u>	L	20	1	00	3000	3000	. –	0.08	100	1
Output Voltage:													
	0	0	L	0,5	5		0	.05			0	0.05	
Low Level, VOL	0	0	L	0,10	10		0	.05			0	0.05	1
MAX.	0	0		0,15	15		0	.05			0	0.05	1
	0	0		0,5	5		4	.95		4.95	5	-	V
High Level, VOH	0	0		0,10	10		9	.95	-	9.95	10		
MIN.	0	0	L	0,15	15		14	1.95		14.95	15		1 1
Input Low Voltage,	0	0	0.5, 4.5		5		1.5				_	1.5	
VIL MAX.	0	0	1,9		10			3				3	- 1
	0	0 1	.5,13.	5	15			4			1 -	4	
Input High	- 5	0	0.5,4.5		5		3	.5	-	3.5			V
Voltage,	0	0	1,9		10			7		7	-		
VIH MIN.	0	0 1	.5,13.5		15		1	11		11	-	-	
Output Low (Sink)	-5	0	-4.5		5	0.98	0.92	0.67	0.55	0.8	1.6		
Current, IOL	0	0	0.5		10	0.98	0.92	0.67	0.55	0.8	1.6	_	
	0	0	1.5		15	3.6	3.4	2.4	2	2.9	5.8		ŀ
Output High	-5	0	4.5		5	-0.6	0.55	0.35	0.3	-0.45	-0.9		mA
(Source)	0	0	9.5		10	0.01 0.55 0.55 0.5							
Current, IOH	0	Ó	13.5		15	-1.9	-1.8	-1.2	-1.1	- 1.5	-3		- 1
Input Current,	0	0	-	0,18	18	±0.1	±0.1	±1	±1	-	±10-5	±0.1	μΑ

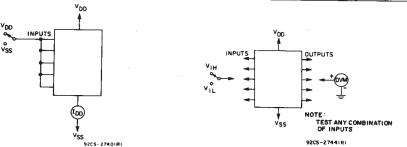


Fig. 11 - Quiescent-device-current test circuit.

Fig. 12 - Input-voltage test circuit.

DYNAMIC ELECTRICAL CHARACTERISTICS at TA = 25°C, CL = 50 pF, Input tr, tr = 20 ns, RL = 200 k Ω

	cor	NDITI							
CHARACTERISTIC	VEE (V)	VSS	V _{DD} (V)	CD4054		CKAGE T	UNITS		
	(4)	(V)		Тур.	Max.	Тур.	Max.		
Propagation Delay Time,	– 5	0	5	400	800	650	1300		
tPHL,tPLH	0	0	10	340	680	575	1150	ns	
(Any Input to Any Output)	0 -	0	15	250	500	375	750		
Transition Time, t _{THL} ,t _{TLH}	-5	0	5	100	200	100	200	ns	
	0	0	10	100	200	100	200		
(Any Output)	0	0	15	75	150	75	150		
Minimum Data Setup	-5	0	5	110	220	110	220		
Time, to*	0	0	10	50	100	50	100	ns	
Time, ts			15	35	70	35	70		
Minimum Strobe Pulse	-5	0	5	110	220	110	220		
	0	0	10	50	100	50	100	ns	
Width, t _W *	0	0	15	35	70	35	70		
Input Capacitance, CIN (Any Input)	_	-	-	5	7.5	5	7.5	pF	

^{*} CD4054 and CD4056 only.

RECOMMENDED OPERATING CONDITIONS at T_A = 25°C (Unless otherwise specified)

For maximum reliability, nominal operating conditions should be selected so that operation is always within the following ranges.

CHARACTERISTIC	VEE	VSS	V _{DD}	LIM	UNITS		
CHARACTERISTIC	(V)	(V)	(V)	Min.	Max.	OIAL L2	
Supply Voltage Range: (At TA = Full Package Temperature Range)				3	18	>	
	5	0	5	220	_		
Setup Time (t _e)●	0	0	10	100		ns	
	0	0	15	70	_		
	-5	-0	5	220			
Strobe Pulse Width (tw)	0	0	10	100		ns	
·	0	0	15	70	_	<u> </u>	

For CD4054 and CD4056 only.

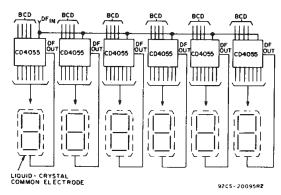


Fig. 16 - Clock display: V_{DD} = 0 V, V_{SS} =-5 V, V_{EE} = -15 V, DF_{IN} = 30 Hz square wave.

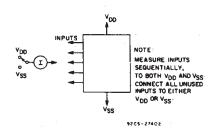


Fig. 14 - Input-current test circuit.

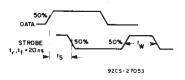
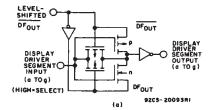


Fig. 15 — Data setup time and strobe pulse duration.



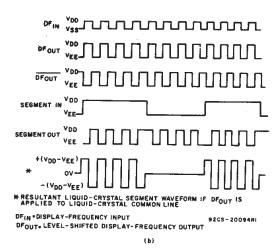


Fig. 17 — Display-driver circuit for one segment line and waveforms,

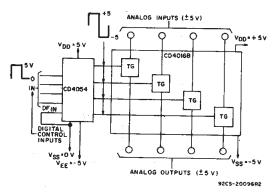


Fig. 18 - Digital (0 to +5 V) to bidirectional analog control (+5 to -5 V) level shifter.

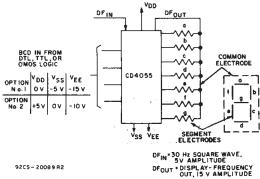


Fig.20 - Single-digit liquid-crystal display.

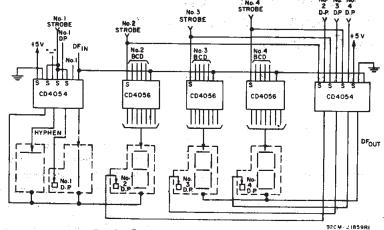


Fig. 19 — Typical 3½-digit liquid-crystal display: V_{DD} = +5 V, V_{SS} = 0 V, V_{EE} = -10 V, DF_{IN} = 30 Hz square wave.

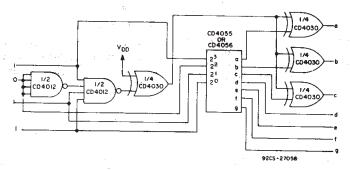


Fig.21 - Conversion of "H" display to "F" display.

Dimensions in parentheses are in millimeters and are derived from the basic inch dimensions as indicated.

Grid graduations are in mils (10⁻³ inch),

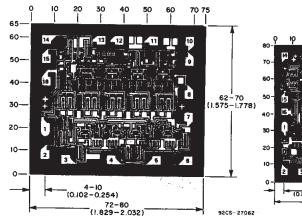
examp display

One of VEE=N

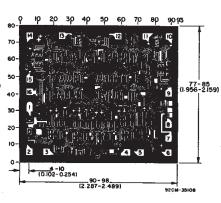
In addition to the letters L, H, P, and A (See the truth table), five other letters can be displayed through the use of simple logic circuits preceding and following the CD4055B or CD4056B devices. Fig.21 is an example of a circuit that converts an "H" display (code 1011) to an "F" display. One condition that must be met is that VEE=VSS. If VEE=VSS, the CD4054B must be used to level shift in the appropriate places.

In a similar manner the letters C, E, J, and U can be displayed. These circuits can also be used to drive LED displays provided the exclusive-OR gates have sufficient output-current drive.

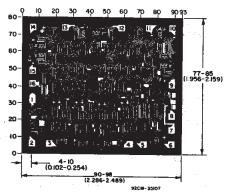
The letters B, D, G, I, O, and S may be represented by the codes for numbers 8, 0, 6, 1, 0, and 5, respectively, when there is preknowledge that only letters are to be displayed.



Dimensions and pad layout for CD4054BH.



Dimensions and pad layout for CD4055BH



Dimensions and pad layout for CD4056BH





28-Feb-2005

PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
CD4054BE	ACTIVE	PDIP	N	16	25	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
CD4054BF3A	ACTIVE	CDIP	J	16	1	None	Call TI	Level-NC-NC-NC
CD4054BM	ACTIVE	SOIC	D	16	40	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR/ Level-1-235C-UNLIM
CD4054BM96	ACTIVE	SOIC	D	16	2500	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR/ Level-1-235C-UNLIM
CD4054BMT	ACTIVE	SOIC	D	16	250	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR/ Level-1-235C-UNLIM
CD4054BNSR	ACTIVE	SO	NS	16	2000	Pb-Free (RoHS)		Level-2-260C-1 YEAR/ Level-1-235C-UNLIM
CD4054BPW	ACTIVE	TSSOP	PW	16	90	Pb-Free (RoHS)	CU NIPDAU	Level-1-250C-UNLIM
CD4054BPWR	ACTIVE	TSSOP	PW	16	2000	Pb-Free (RoHS)	CU NIPDAU	Level-1-250C-UNLIM
CD4055BE	ACTIVE	PDIP	N	16	25	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
CD4055BM	ACTIVE	SOIC	D	16	40	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR/ Level-1-235C-UNLIM
CD4055BM96	ACTIVE	SOIC	D	16	2500	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR/ Level-1-235C-UNLIM
CD4055BMT	ACTIVE	SOIC	D	16	250	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR/ Level-1-235C-UNLIM
CD4055BNSR	ACTIVE	SO	NS	16	2000	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR/ Level-1-235C-UNLIM
CD4055BPW	ACTIVE	TSSOP	PW	16	90	Pb-Free (RoHS)	CU NIPDAU	Level-1-250C-UNLIM
CD4055BPWR	ACTIVE	TSSOP	PW	16	2000	Pb-Free (RoHS)	CU NIPDAU	Level-1-250C-UNLIM
CD4056BE	ACTIVE	PDIP	N	16	25	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
CD4056BF	ACTIVE	CDIP	J	16	1	None	Call TI	Level-NC-NC-NC
CD4056BF3A	ACTIVE	CDIP	J	16	1	None	Call TI	Level-NC-NC-NC
CD4056BM	ACTIVE	SOIC	D	16	40	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR/ Level-1-235C-UNLIM
CD4056BM96	ACTIVE	SOIC	D	16	2500	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR/ Level-1-235C-UNLIM
CD4056BMT	ACTIVE	SOIC	D	16	250	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR/ Level-1-235C-UNLIM
CD4056BNSR	ACTIVE	SO	NS	16	2000	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR/ Level-1-235C-UNLIM
CD4056BPW	ACTIVE	TSSOP	PW	16	90	Pb-Free (RoHS)	CU NIPDAU	Level-1-250C-UNLIM
CD4056BPWR	ACTIVE	TSSOP	PW	16	2000	Pb-Free (RoHS)	CU NIPDAU	Level-1-250C-UNLIM

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in



PACKAGE OPTION ADDENDUM

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a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - May not be currently available - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

None: Not yet available Lead (Pb-Free).

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Green (RoHS & no Sb/Br): TI defines "Green" to mean "Pb-Free" and in addition, uses package materials that do not contain halogens, including bromine (Br) or antimony (Sb) above 0.1% of total product weight.

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDECindustry standard classifications, and peak solder temperature.

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14 LEADS SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package is hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
- E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

N (R-PDIP-T**)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- The 20 pin end lead shoulder width is a vendor option, either half or full width.



D (R-PDSO-G16)

PLASTIC SMALL-OUTLINE PACKAGE



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
- D. Falls within JEDEC MS-012 variation AC.



MECHANICAL DATA

NS (R-PDSO-G**)

14-PINS SHOWN

PLASTIC SMALL-OUTLINE PACKAGE



- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



PW (R-PDSO-G**)

14 PINS SHOWN

PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.

D. Falls within JEDEC MO-153

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Mailing Address: Texas Instruments

Post Office Box 655303 Dallas, Texas 75265

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